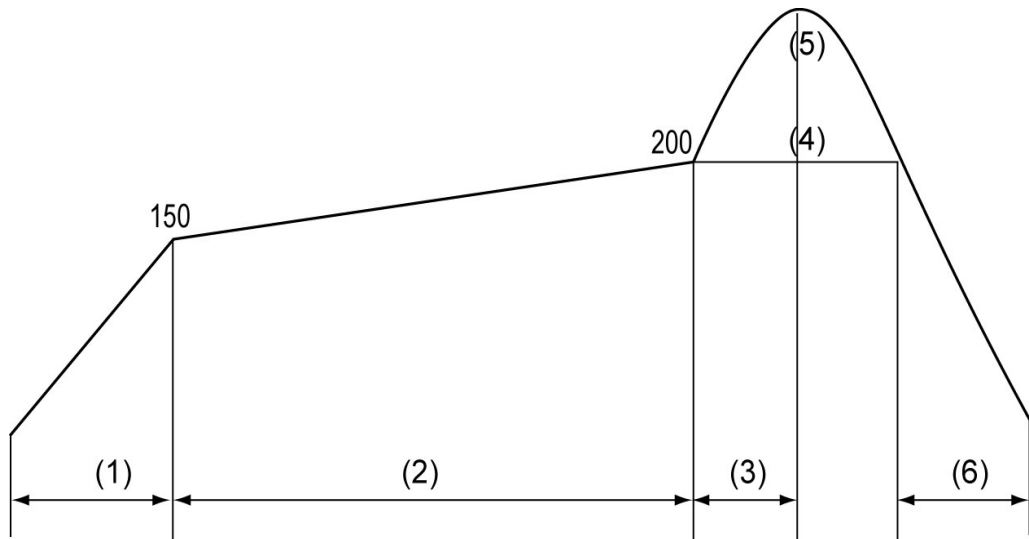




CD-SP1

Recommended Solder Reflow Profile



Ref	Parameter	Specification
1	Ramp Up to 150°C	< 3°C/s
2	Preheating 150°C to 200°C	Max 120 seconds
3	200°C to Peak	1~ 4°C/s
4	Soldering Zone >220°C	Max 60 seconds
5	Peak Temperature <260°C	Max 10 seconds
6	Ramp Down	1~ 4°C/s